



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Akram et al.

**Serial No.:** 10/701,957

**Filed:** November 5, 2003

**For:** METHOD FOR SAWING WAFERS  
EMPLOYING MULTIPLE INDEXING  
TECHNIQUES FOR MULTIPLE DIE  
DIMENSIONS AND DICING APPARATUS

**Confirmation No.:** 8101

**Examiner:** M. Rachuba

**Group Art Unit:** 3723

**Attorney Docket No.:** 2269-2874.20US  
(96-0032.17/US)

**Notice of Allowance Mailed:**

March 31, 2005

Express Mail Mailing Label No.: EL 994848968 US

Date of Deposit with USPS: June 30, 2005

Person making Deposit: Steve Wong

**AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

**Serial No. 10/701,957**

**Amendments to the Specification** begin on page 3 of this paper.

**A Listing of the Claims** begins on page 6 of this paper.

**Remarks** begin on page 10 of this paper.